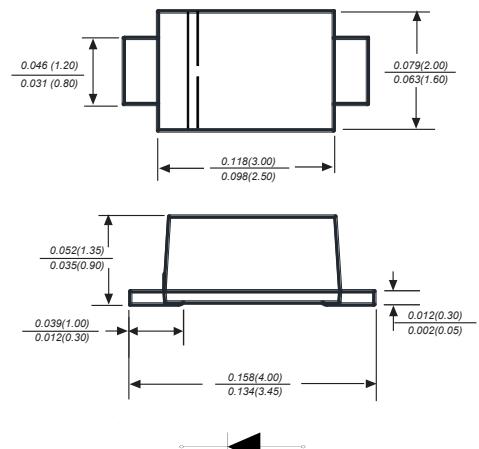


## SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

### Features

- ◆ The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- ◆ For surface mounted applications
- ◆ Metal silicon junction,majority carrier conduction
- ◆ Low power loss,high efficiency
- ◆ Built-in strain relief,ideal for automated placement
- ◆ High forward surge current capability
- ◆ High temperature soldering guaranteed:  
250 °C/10 seconds at terminals

**SOD-123FL**



Dimensions in inches and (millimeters)

### Mechanical Data

Case : JEDEC SOD-123FL molded plastic body

Terminals : Solderable per MIL-STD-750, Method

2026 Polarity : Color band denotes cathode end

Mounting Position : Any

Weight : 0.0007 ounce, 0.02 grams

### Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

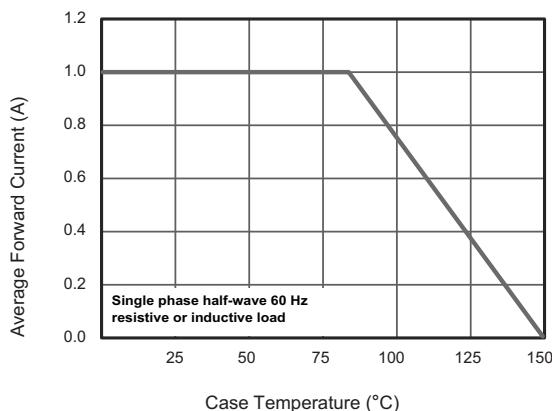
Single phase half-wave 60Hz,resistive or inductive load,for capacitive load current derate by 20%.

| Parameter  | SYMBOLS           | DSK12 | DSK14 | DSK15       | DSK16 | DSK18 | DSK110 | DSK115 | DSK120 | UNITS |
|--|-------------------|-------|-------|-------------|-------|-------|--------|--------|--------|-------|
| Marking Code   |                   | K12   | K14   | K15         | K16   | K18   | K110   | K115   | K120   |       |
| Maximum repetitive peak reverse voltage  | V <sub>RRM</sub>  | 20    | 40    | 50          | 60    | 80    | 100    | 150    | 200    | V     |
| Maximum RMS voltage  | V <sub>RMS</sub>  | 14    | 28    | 35          | 42    | 56    | 70     | 105    | 140    | V     |
| Maximum DC blocking voltage  | V <sub>DC</sub>   | 20    | 40    | 50          | 60    | 80    | 100    | 150    | 200    | V     |
| Maximum average forward rectified current at TL(see fig.1)   | I <sub>(AV)</sub> |       |       |             |       |       | 1.0    |        |        | A     |
| Peak forward surge current<br>8.3ms single half sine-wave superimposed onrated load (JEDEC Method) | I <sub>FSM</sub>  |       |       |             |       |       | 25     |        |        | A     |
| Maximum instantaneous forward voltage at 1.0A  | V <sub>F</sub>    | 0.55  | 0.70  |             |       | 0.85  |        | 0.90   |        | V     |
| Maximum DC reverse current TA=25°C<br>at rated DCblocking voltage TA=100°C                         | I <sub>R</sub>    |       |       | 0.3         |       | 0.2   |        | 0.1    |        | mA    |
|  |                   |       |       | 10.0        |       | 5.0   |        | 2.0    |        |       |
| Typical junction capacitance (NOTE 1)  | C <sub>J</sub>    | 110   |       |             | 80    |       |        |        |        | pF    |
| Typical thermal resistance (NOTE 2)  | R <sub>θJA</sub>  |       |       | 100.0       |       |       |        |        |        | °C/W  |
| Operating junction temperature range   | T <sub>J</sub>    |       |       | -55 to +150 |       |       |        |        |        | °C    |
| Storage temperature range  | T <sub>STG</sub>  |       |       | -55 to +150 |       |       |        |        |        | °C    |

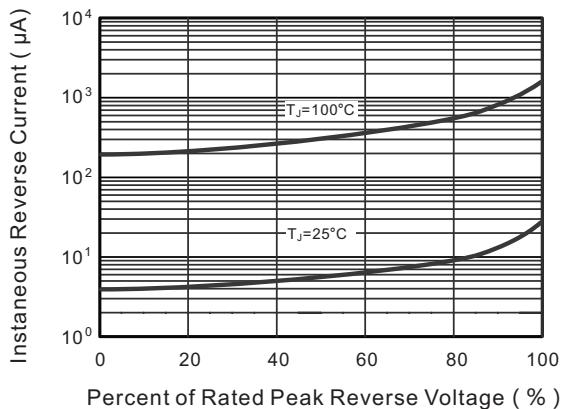
Note:1.Measured at 1MHz and applied reverse voltage of 4.0V D.C.

## Typical Characteristics

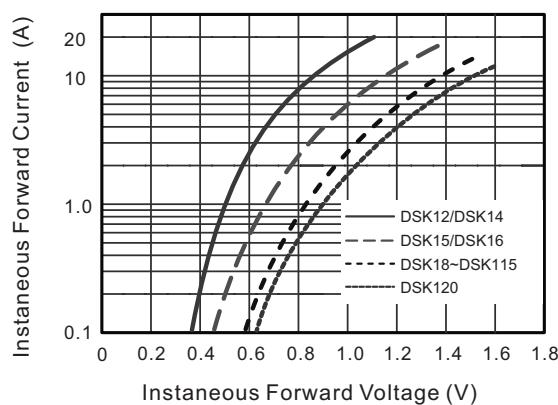
**Fig.1 Forward Current Derating Curve**



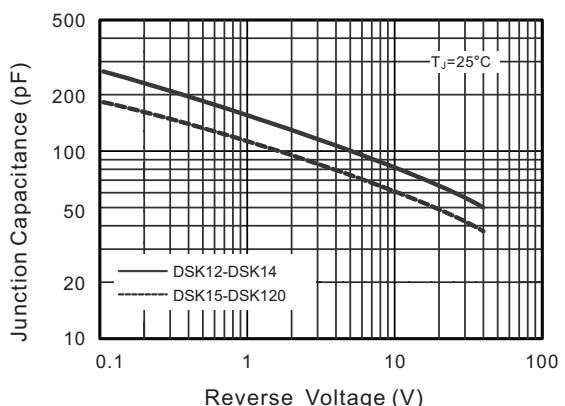
**Fig.2 Typical Reverse Characteristics**



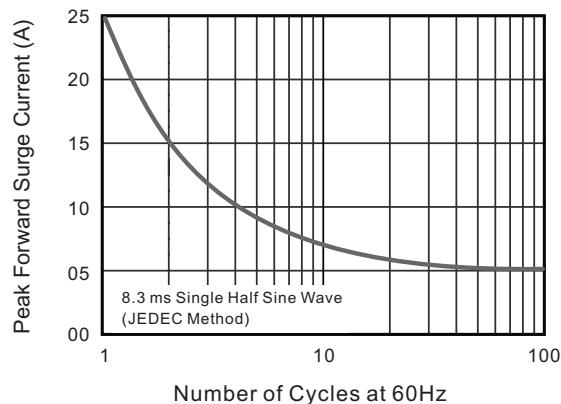
**Fig.3 Typical Forward Characteristic**



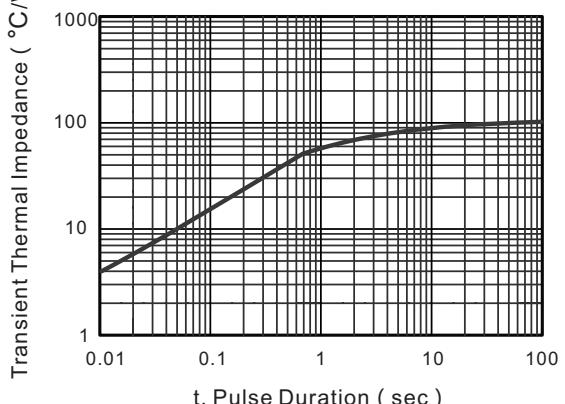
**Fig.4 Typical Junction Capacitance**



**Fig.5 Maximum Non-Repetitive Peak Forward Surge Current**

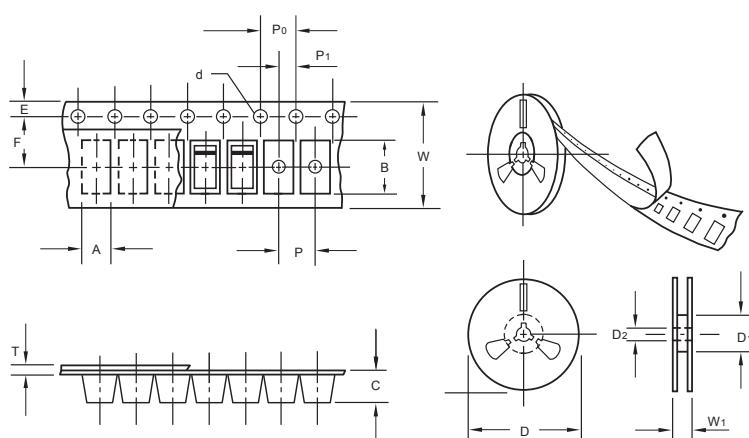


**Fig.6- Typical Transient Thermal Impedance**



The curve above is for reference only.

## Packing information



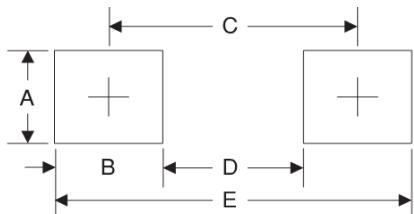
| Item                     | Symbol         | Tolerance | SOD-123FL |
|--------------------------|----------------|-----------|-----------|
| Carrier width            | A              | 0.1       | 2.1       |
| Carrier length           | B              | 0.1       | 4.0       |
| Carrier depth            | C              | 0.1       | 1.60      |
| Sprocket hole            | d              | 0.05      | 1.55      |
| 7" Reel outside diameter | D              | 2.0       | 178.00    |
| 7" Reel inner diameter   | D <sub>1</sub> | min       | 50.0      |
| Feed hole diameter       | D <sub>2</sub> | 0.5       | 13.00     |
| Sprocket hole position   | E              | 0.1       | 1.75      |
| Punch hole position      | F              | 0.1       | 3.50      |
| Punch hole pitch         | P              | 0.1       | 4.00      |
| Sprocket hole pitch      | P <sub>0</sub> | 0.1       | 4.00      |
| Embossment center        | P <sub>1</sub> | 0.1       | 2.00      |
| Overall tape thickness   | T              | 0.1       | 0.25      |
| Tape width               | W              | 0.3       | 8.15      |
| Reel width               | W <sub>1</sub> | 1.0       | 10.5      |

Note: Devices are packed in accordance with EIA standard RS-481-A and specifications listed above.

## Reel packing

| PACKAGE   | REEL SIZE | REEL (pcs) | COMPONENT SPACING (m/m) | BOX (pcs) | INNER BOX (m/m) | REEL DIA, (m/m) | CARTON SIZE (m/m) | CARTON (pcs) |
|-----------|-----------|------------|-------------------------|-----------|-----------------|-----------------|-------------------|--------------|
| SOD-123FL | 7"        | 3,000      | 4.0                     | 45,000    | 190*190*190     | 178             | 400*400*220       | 180,000      |

## Suggested Pad Layout



| Symbol | Unit (mm) | Unit (inch) |
|--------|-----------|-------------|
| A      | 1.2       | 0.047       |
| B      | 1.2       | 0.047       |
| C      | 3.2       | 0.126       |
| D      | 2         | 0.079       |
| E      | 4.4       | 0.173       |

## Important Notice and Disclaimer

Microdiode Electronics (Shenzhen) reserves the right to make changes to this document and its products and specifications at any time without notice. Customers should obtain and confirm the latest product information and specifications before final design, purchase or use.

Microdiode Electronics (Shenzhen) makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does Microdiode Electronics (Shenzhen) assume any liability for application assistance or customer product design. Microdiode Electronics (Shenzhen) does not warrant or accept any liability with products which are purchased or used for any unintended or unauthorized application.

No license is granted by implication or otherwise under any intellectual property rights of Microdiode Electronics (Shenzhen).

Microdiode Electronics (Shenzhen) products are not authorized for use as critical components in life support devices or systems without express written approval of Microdiode Electronics (Shenzhen).